QPC6054
5 MHz to 6 GHz Absorptive High Isolation SP5T Switch

## Product Overview

The QPC6054 is a Silicon on Insulator (SOI) Single-Pole 5Throw (SP5T) switch designed for uses in cellular, 3G, LTE and other high-performance communication systems. It offers a high isolation, identical throw ports with excellent linearity and power handling capability. No DC blocking capacitors are necessary on the RF ports. The design is non-reflective as such the RF1, RF2, RF3, RF4 and RF5 ports are terminated with $50 \Omega \operatorname{load}(\mathrm{~s})$ in the non-throw or All OFF state. The QPC6054 is 1.8 V positive control logic compatible. It incorporates the control to disable the internal Negative Voltage Generator (NVG) and the required negative voltage supplied by an off-chip external source to the same pin.

## Functional Block Diagram



Top View


$$
\text { 24-Pin, } 4 \times 4 \text { mm QFN Package }
$$

## Key Features

- $5-6000 \mathrm{MHz}$ Operation
- Single Pole 5 Throw
- Non-Reflective RF1, RF2, RF3, RF4 \& RF5 Ports, Terminated in ALL-OFF State
- No Blocking Capacitors Necessary Unless DC Voltage on RF line
- High Isolation: 60 dB at 2 GHz
- High Input IP3: +59 dBm
- +1.8 V Control Logic Compatible


## Applications

- Cellular, 3G, 4G, 5G Infrastructure
- WiBro, WiMax, LTE
- High Performance Communication Systems
- Test Equipment


## Ordering Information

| Part No. | Description |
| :--- | :--- |
| QPC6054TR13 | 2,500 pieces on a 13" reel (standard) |
| QPC6054 PCK410 | $5 \mathrm{MHz}-6 \mathrm{GHz}$ Evaluation Board <br> with 5-piece samples |

## Absolute Maximum Ratings

| Parameter |  | Rating |
| :---: | :---: | :---: |
| Storage Temperature |  | -55 to $+150^{\circ} \mathrm{C}$ |
| RF Input Power, non-internally terminated |  | +37.5 dBm |
| RF Input Power, RFX terminated |  | +29 dBm |
| Device Voltage | (VDD) | +6 V |
|  | (VSS) | -6 V |
| Control Voltage | (V1, V2, V3) Low / High | -0.2 V / +6 V |
| Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. |  |  |

## Recommended Operating Conditions

| Parameter | Min | Typ | Max | Units |
| :--- | :---: | :---: | :---: | :---: |
| Device Voltage (VDD) | +2.7 | +5.0 | +5.5 | V |
| Device Voltage (VSS), External <br> Negative Voltage Supply | -5.5 | -5.0 | -2.7 | V |
| Device Voltage (VSS), Internal <br> Negative Voltage Generator |  | 0 |  | V |
| TCASE | -40 | +25 | +105 | ${ }^{\circ} \mathrm{C}$ |
| Tj for $\geq 10^{6}$ hours MTTF |  |  | +125 | ${ }^{\circ} \mathrm{C}$ |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

## Electrical Specifications

| Parameter | Conditions ${ }^{(1)}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Operational Frequency Range |  | 5 |  | 6000 | MHz |
| Insertion Loss (2) <br> (RFC to RF1/RF2/RF3/RF4/RF5) | 450 MHz |  | 0.95 | 1.15 | dB |
|  | 900 MHz |  | 1.00 | 1.20 | dB |
|  | 2100 MHz |  | 1.10 | 1.30 | dB |
|  | 2600 MHz |  | 1.17 | 1.40 | dB |
|  | 4000 MHz |  | 1.40 | 1.70 | dB |
|  | 6000 MHz |  | 1.90 | 2.20 | dB |
| Group Delay | ON Path |  | 0.1 | 0.5 | ns |
| Isolation ${ }^{(3)}$ <br> (RFC to RF1/RF2/RF3/RF4) | 450 MHz | 61 | 70 |  | dB |
|  | 900 MHz | 57 | 63 |  | dB |
|  | 2100 MHz | 48 | 56 |  | dB |
|  | 2600 MHz | 48 | 54 |  | dB |
|  | 4000 MHz | 45 | 50 |  | dB |
|  | 5000 MHz | 45 | 50 |  | dB |
|  | 6000 MHz | 40 | 50 |  | dB |
| Isolation ${ }^{(3)}$ <br> (RF1/2/3/4/5 to RF1/2/3/4/5) | 450 MHz | 61 | 70 |  | dB |
|  | 900 MHz | 56 | 66 |  | dB |
|  | 2100 MHz | 50 | 59 |  | dB |
|  | 2600 MHz | 48 | 56 |  | dB |
|  | 4000 MHz | 43 | 50 |  | dB |
|  | 5000 MHz | 41 | 48 |  | dB |
|  | 6000 MHz | 38 | 44 |  | dB |
| Isolation (RF1 - RF4) ${ }^{(3)}$ | 3500 MHz | 50 | 56 |  | dB |
| Isolation (RF2-RF1, RF2 ON) ${ }^{(4)}$ | 5000 MHz | 41 | 42.3 |  | dB |
| Isolation (RF3-RF2, RF3 ON) ${ }^{(4)}$ | 5000 MHz | 41 | 42.8 |  | dB |
| Isolation (RF4-RF3, RF4 ON) ${ }^{(4)}$ | 5000 MHz | 43 | 44.8 |  | dB |
| Isolation (RF5-RF4, RF5 ON) ${ }^{(4)}$ | 5000 MHz | 40 | 41.7 |  | dB |
| Isolation (RF5-RF1, RF5 ON) ${ }^{(4)}$ | 5000 MHz | 43 | 45 |  | dB |

## Notes:

1. Test conditions unless otherwise noted: VDD $=+5 \mathrm{~V} ; \mathrm{V} 1, \mathrm{~V} 2$ and $\mathrm{V} 3=0 /+5 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$; Standard application circuit; $50 \Omega$ system,
2. PCB trace loss deducted
3. Isolation based on an optimized evaluation board
4. Only these RF path-ports listed, and the other ports' isolation is better.

Electrical Specifications (continued)

| Parameter | Conditions ${ }^{(1)}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Operational Frequency Range |  | 5 |  | 6000 | MHz |
| Return Loss (RF1/RF2/RF3/RF4/RF5 ON-State) | 450 MHz |  | 30 |  | dB |
|  | 900 MHz |  | 31 |  | dB |
|  | 2100 MHz |  | 31 |  | dB |
|  | 2600 MHz |  | 30 |  | dB |
|  | 4000 MHz |  | 20 |  | dB |
|  | 5000 MHz |  | 16 |  | dB |
|  | 6000 MHz |  | 12 |  | dB |
| Return Loss <br> (RF1/RF2/RF3/RF4/RF5 OFF-State) | 450 MHz |  | 37 |  | dB |
|  | 900 MHz |  | 30 |  | dB |
|  | 2100 MHz |  | 24 |  | dB |
|  | 2600 MHz |  | 23 |  | dB |
|  | 4000 MHz |  | 22 |  | dB |
|  | 5000 MHz |  | 19 |  | dB |
|  | 6000 MHz |  | 14 |  | dB |
| Input IP2 | 1000 MHz |  | 117 |  | dBm |
| Input IP3 | $1.0 \mathrm{GHz},+17 \mathrm{dBm}$ input power per-tone, <br> 1 MHz tone spacing | 55 | 59 |  | dBm |
| Input 1 dB Compression Power |  | 36 |  |  | dBm |
| NVG Spur | Internal Negative Voltage Generator ON |  | -104 |  | dBm |
| Spurious Signal Level | $>100 \mathrm{MHz}$ |  |  | -120 | dBm |
| Second Harmonic | Pin $=+13 \mathrm{dBm}, \mathrm{F}_{0}=1 \mathrm{GHz}$ |  | -105 | -95 | dBc |
| Third Harmonic | Pin $=+13 \mathrm{dBm}, \mathrm{F}_{0}=1 \mathrm{GHz}$ |  | -105 | -95 | dBc |
| Setting Time | 50\% V1/V2/V3 to optimum functionality |  | 1 | 4 | $\mu \mathrm{s}$ |
| Start-up Time | 90\% VDD to full functionality |  | 5 | 25 | $\mu \mathrm{s}$ |
| Switching Time | 50\% control to 10/90\% RF |  | 150 | 240 | ns |
| Supply Current (Ivdd) | VDD +5.0V |  | 100 |  | $\mu \mathrm{A}$ |
| Control Current, (Iv1, I v2, Iv3) | $\mathrm{V} 1, \mathrm{~V} 2, \mathrm{~V} 3$ each at +5.0 V |  | 2 |  | $\mu \mathrm{A}$ |
| VSS Current (lvss) | VSS -5.0V, Internal NVG disabled |  | 100 |  | $\mu \mathrm{A}$ |
| Low Control Voltage (V1, V2, V3) | +1.8 V Control Logic compatible | 0 |  | 0.63 | V |
| High Control Voltage (V1, V2, V3) |  | 1.1 |  | VDD | V |

## Notes:

1. Test conditions unless otherwise noted: VDD $=+5 \mathrm{~V} ; \mathrm{V} 1, \mathrm{~V} 2$ and $\mathrm{V} 3=0 /+5 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$; Standard application circuit; $50 \Omega$ system

## Truth Table

| Control Input |  |  | Mode |
| :---: | :---: | :---: | :---: |
| V1 | V2 | V3 | of Signal Path |
| 0 | 0 | 0 | All OFF; RFC Reflective; RFX Terminated |
| 1 | 0 | 0 | RFC $\leftrightarrows$ RF1 Active ON |
| 0 | 1 | 0 | RFC $\leftrightarrows$ RF2 Active ON |
| 1 | 1 | 0 | RFC $\leftrightarrows$ RF3 Active ON |
| 0 | 0 | 1 | RFC $\leftrightarrows$ RF4 Active ON |
| 1 | 0 | 1 | RFC $\leftrightarrows$ RF5 Active ON |
| 0 | 1 | 1 | All OFF; RFC Reflective; RFX Terminated |
| 1 | 1 | 1 |  |

## Maximum Operating Power at High Temperature, $\geq 50 \mathrm{MHz}$ CW, $50 \Omega$ System

| Input Port | State | Power at each port |  | Thermal Resistance, $\boldsymbol{\theta}_{\text {jc }}$ |
| :---: | :---: | :---: | :---: | :---: |
| RFC, RF1, RF2, RF3, RF4 or RF5 | ON, Active Throw | 35.5 dBm | 32.3 dBm ${ }^{(1)}$ | $53^{\circ} \mathrm{C} / \mathrm{W}$ |
| RF1, RF2, RF3, RF4 or RF5 | OFF, 1 port | 28.1 dBm | 25.1 dBm ${ }^{(3)}$ | $61^{\circ} \mathrm{C} / \mathrm{W}$ |
| RF1, RF2, RF3, RF4, RF5 | OFF, 2 ports adjacent | 26.6 dBm | 23.6 dBm ${ }^{(2)(3)}$ | $86^{\circ} \mathrm{C} / \mathrm{W}$ |
| RF1, RF2, RF3, RF4 and RF5 | OFF, All 5 ports | 26.2 dBm | $23.1 \mathrm{dBm}{ }^{(3)}$ | $96^{\circ} \mathrm{C} / \mathrm{W}$ |

Notes:

1. For frequency $<50 \mathrm{MHz}$, the maximum operating power at all temperatures should be at least 2 dB below P1dB refer to performance plot
2. On any two ports adjacent being driven simultaneously
3. Internally terminated OFF state

QPC6054


## Bill of Material - QPC6054PCK410

| Reference Des. | Value | Description | Manuf. | Part Number |
| :--- | :---: | :--- | :---: | :--- |
| - | - | PCB, QPC6064-410(B) | Qorvo | 279707 |
| U1 | - | SOI, High Isolation SP5T RF switch | Qorvo | QPC6054 |
| C1, C2, C3, C4, C5 | 100 pF | CAP, 100 pF, 5\%, 50V, C0G, 0402 | Taiyo Yuden | RM UMK105 CG101JV-F |
| J1, J2, J3, J4, J5, J6 | SMA | CONN, SMA, EL, FLT VIPER, MAT-21-1038 | Amphenol | $901-10425$ |
| P1 | - | CONN, HDR, ST, PLRZD, 6-Pin, 0.100" | AMP | $640454-6$ |

## Performance Plots - QPC6054PCK410








## Performance Plots - QPC6054PCK410 (Continued)







## Pad Configuration and Description



Top View

| Pad No. | Label | Description |
| :--- | :--- | :--- |
| $1,3,4,6,7,9,10$, <br> $12,13,15,21,23,24$ | GND | DC and RF ground, connect to low inductive path to PCB ground |
| 2 | RF5 | RF Port 5 |
| 5 | RF4 | RF Port 4 |
| 8 | RF3 | RF Port 3 |
| 11 | RF2 | RF Port 2 |
| 14 | RF1 | RF Port 1 |
| 16 | VDD | DC Supply Voltage Input |
| 17 | V1 | Control Input 1 |
| 18 | V2 | Control Input 2 |
| 19 | V3 | Control Input 3 |
| 20 | VSS/GND | Negative DC Supply Voltage and Internal Negative Voltage Generator (NVG) control input. Provide <br> low inductive ground connection on this pin to enable internal NVG or directly connect -2.7V to -5V <br> external voltage supply to disable the internal NVG. Re-enable internal NVG, VDD cycling required |
| 22 | RFC | RF Common Port |
| Backside Paddle | GND | RF and DC ground. Must be soldered on PCB ground plane over a bed of via holes to minimize <br> inductance and thermal resistance |

## Package Marking and Dimensions

Marking: Part Number - QPC
6054
Trace Code -Assigned by subcontractor


Notes:

1. All dimensions are in millimeters. Angles are in degrees.
2. The terminal \#1 identifier and terminal numbering conform to JESD 95-1 SPP-012.
3. Contact plating: NiPdAu

## PCB Mounting Pattern




$\frac{\text { Difin }}{\sin } \mathrm{A}$


## Notes:

1. All dimensions are in millimeters. Angles are in degrees.
2. Use 1 oz . copper minimum for top and bottom layer metal.
3. Via holes are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35 mm (\#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of $0.25 \mathrm{~mm}(0.01$ ").
4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.

## Tape and Reel Information - Carrier and Cover Tape Dimensions



| Feature |  | Measure | Symbol | Size (in) |
| :--- | :--- | :---: | :---: | :---: |
| Cavity | Length | A0 | 0.169 | 4.30 |
|  | Width | B0 | 0.169 | 4.30 |
|  | Depth | K0 | 0.059 | 1.50 |
|  | Pitch | P1 | 0.314 | 8.00 |
| Centerline Distance | Cavity to Perforation - Length Direction | P2 | 0.079 | 2.00 |
|  | Cavity to Perforation - Width Direction | F | 0.217 | 5.50 |
| Cover Tape | Width | C | 0.362 | 9.20 |
| Carrier Tape | Width | W | 0.472 | 12.0 |

## Tape and Reel Information - Reel Dimensions

Standard T/R size $=2,500$ pieces on a $13^{\prime \prime}$ reel.


| Feature | Measure | Symbol |  | Size (in) |  | Size (mm) |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
|  | Diameter | A | 12.992 | 330.0 |  |  |
|  | Thickness | W 2 | 0.717 | 18.2 |  |  |
|  | Space Between Flange | W 1 | 0.504 | 12.8 |  |  |
| Hub | Outer Diameter | N | 4.016 | 102.0 |  |  |
|  | Arbor Hole Diameter | C | 0.512 | 13.0 |  |  |
|  | Key Slit Width | B | 0.079 | 2.0 |  |  |
|  | Key Slit Diameter | D | 0.787 | 20.0 |  |  |

## Tape and Reel Information - Tape Length and Label Placement



[^0]
## Handling Precautions

| Parameter | Rating | Standard |  |  |
| :--- | :--- | :--- | :--- | :--- |
| ESD-Human Body Model (HBM) | Class 2 | ESDA/ JEDEC JS-001-2012 |  | Caution! |
| ESD-Charged Device Model (CDM) | Class C3 | JEDEC JESD22-C101F |  |  |
| MSL-Moisture Sensitivity Level | Level 2 | IPC/JEDEC J-STD-020 |  |  |

## Solderability

Compatible with both lead-free ( $260^{\circ} \mathrm{C}$ max. reflow temp.) and tin/lead ( $245^{\circ} \mathrm{C}$ max. reflow temp.) soldering processes.
Solder profiles available upon request.
Contact plating: NiPdAu

## RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A $\left(\mathrm{C}_{15} \mathrm{H}_{12} \mathrm{Br}_{4} \mathrm{O}_{2}\right)$ Free
- SVHC Free



## Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

## Web: www.gorvo.com

Tel: 1-844-890-8163
Email: customer.support@qorvo.com

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HMC986A SKY13374-397LF SKY13453-385LF CG2430X1-C2 CG2415M6-C2 HMC986A-SX SW-314-PIN UPG2162T5N-E2-A
SKY13416-485LF MASWSS0204TR-3000 MASWSS0201TR MASWSS0181TR-3000 MASW-007588-TR3000 MASW-004103-13655P MASW-003102-13590G MASWSS0202TR-3000 MA4SW310B-1 MA4SW110 SW-313-PIN CG2430X1 SKY13321-360LF SKY13405490LF BGSF 18DM20 E6327 SKY13415-485LF MMS008PP3 BGS13PN10E6327XTSA1 SKY13319-374LF BGS14PN10E6327XTSA1 SKY12213-478LF SKY13404-466LF MASW-011060-TR0500 SKYA21024


[^0]:    Notes:

    1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
    2. Labels are placed on the flange opposite the sprockets in the carrier tape.
